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Silicon N Channel MOS FET High Speed Power Switching

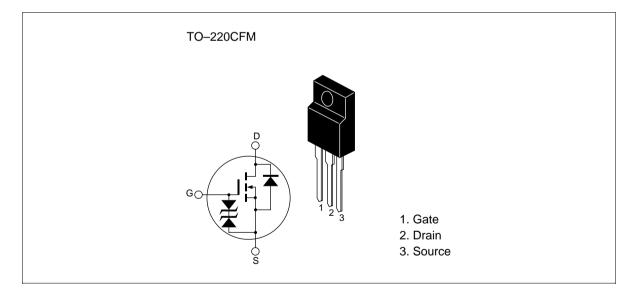


ADE-208-558B (Z) 3rd. Edition Jul. 1998

Features

- Low on-resistance
 - $R_{DS} = 0.020 \Omega$ typ.
- High speed switching
- 4V gate drive device can be driven from 5V source

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	35	A
Drain peak current	Note1 D(pulse)	140	A
Body-drain diode reverse drain current	I _{DR}	35	A
Avalanche current	AP Note3	35	A
Avalanche energy	E _{AR} ^{Note3}	105	mJ
Channel dissipation	Pch Note2	30	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Note: 1. PW \leq 10µs, duty cycle \leq 1 %

2. Value at Tc = 25°C

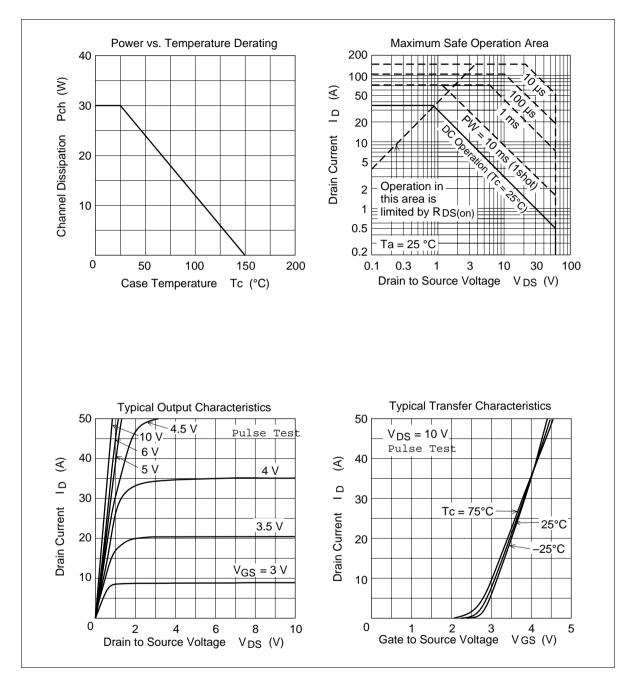
3. Value at Tch = 25° C, Rg 50 Ω

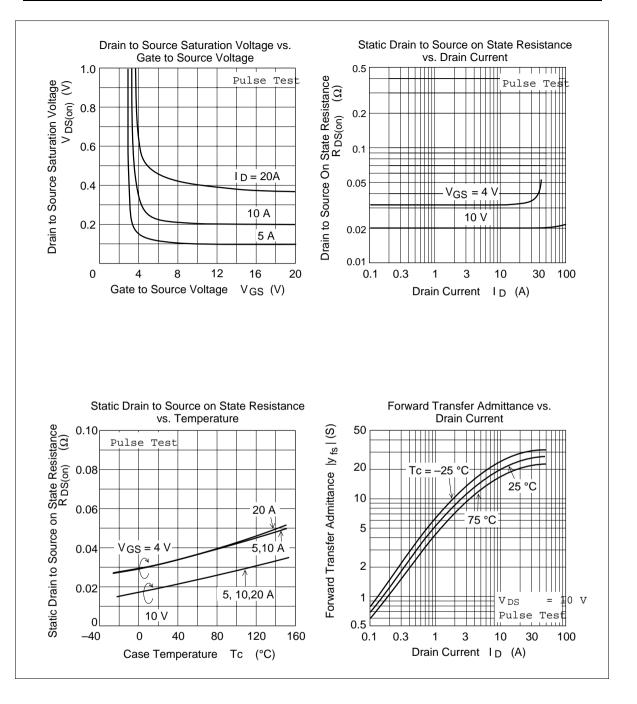
Electrical Characteristics (Ta = 25° C)

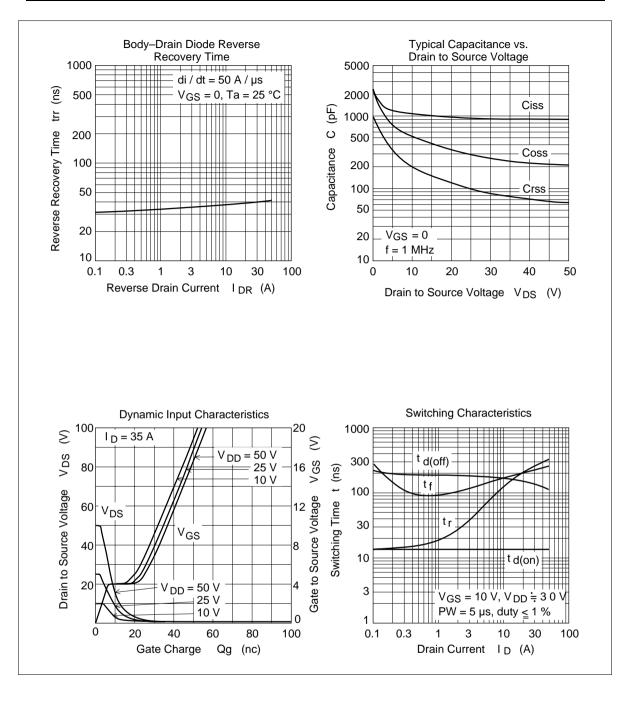
V _{(BR)DSS} V _{(BR)GSS} I _{GSS} I _{DSS} V _{GS(off)}	60 ±20 — 1.5		— ±10 10	V V μΑ	$I_{D} = 10mA, V_{GS} = 0$ $I_{G} = \pm 100\mu A, V_{DS} = 0$ $V_{GS} = \pm 16V, V_{DS} = 0$
I _{GSS} I _{DSS} V _{GS(off)}			-	μA	
I _{DSS} V _{GS(off)}	— — 1.5	_	-	•	$V_{GS} = \pm 16V, V_{DS} = 0$
V _{GS(off)}	— 1.5	_	10		
	1.5			μA	$V_{\rm DS} = 60 \ V, \ V_{\rm GS} = 0$
R	-	—	2.5	V	$I_{\rm D} = 1$ mA, $V_{\rm DS} = 10$ V
DS(on)	_	0.020	0.026	Ω	$I_{\rm D} = 15$ A, $V_{\rm GS} = 10 V^{\rm Note4}$
$R_{\text{DS(on)}}$	_	0.032	0.050	Ω	$I_D = 15A$, $V_{GS} = 4V^{Note4}$
y _{fs}	14	23	_	S	$I_{\rm D} = 15$ A, $V_{\rm DS} = 10$ V ^{Note4}
Ciss	_	1100	_	pF	V _{DS} = 10V
Coss	_	540	_	pF	V _{GS} = 0
Crss	_	200	_	pF	f = 1MHz
t _{d(on)}	_	15	_	ns	I _D = 15A, V _{GS} = 10V
t,	_	180	_	ns	$R_{L} = 2\Omega$
t _{d(off)}		175	_	ns	_
t _r	_	195	—	ns	_
V _{DF}	_	0.95	—	V	$I_{\rm F} = 35$ A, $V_{\rm GS} = 0$
t _{rr}	—	40	—	ns	I _F = 35A, V _{GS} = 0 diF/ dt =50A/µs
1	Y _{fs} Ciss Coss Crss t _{d(on)} t _r t _{d(off)} t _f	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c ccccc} R_{DS(on)} & - & 0.032 \\ y_{fs} & 14 & 23 \\ \hline Ciss & - & 1100 \\ \hline Coss & - & 540 \\ \hline Crss & - & 200 \\ \hline t_{d(on)} & - & 15 \\ t_r & - & 180 \\ \hline t_{d(off)} & - & 175 \\ t_f & - & 195 \\ \hline V_{DF} & - & 0.95 \\ \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

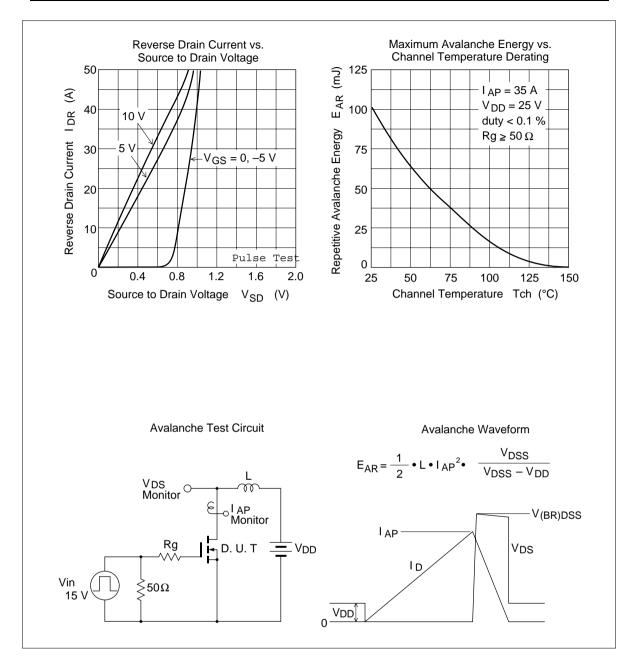
Note: 4. Pulse test

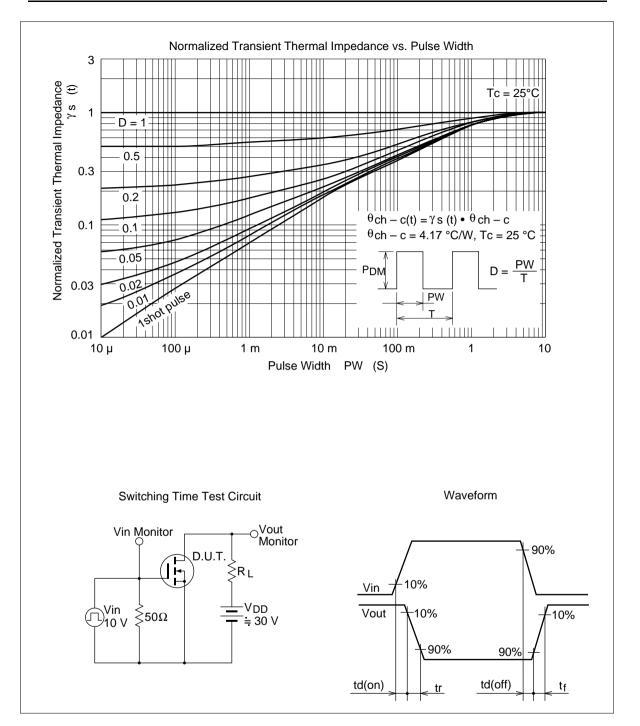
Main Characteristics



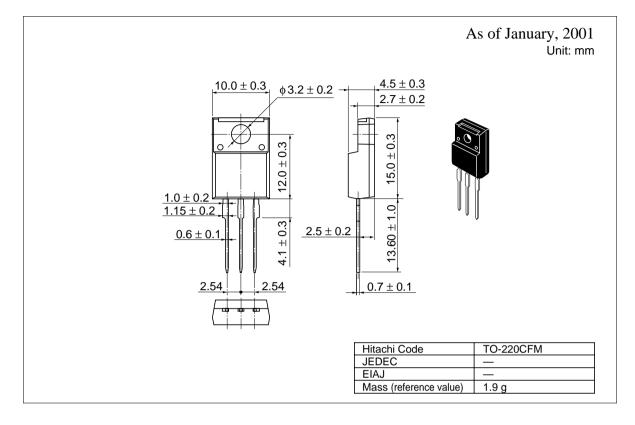








Package Dimensions



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